

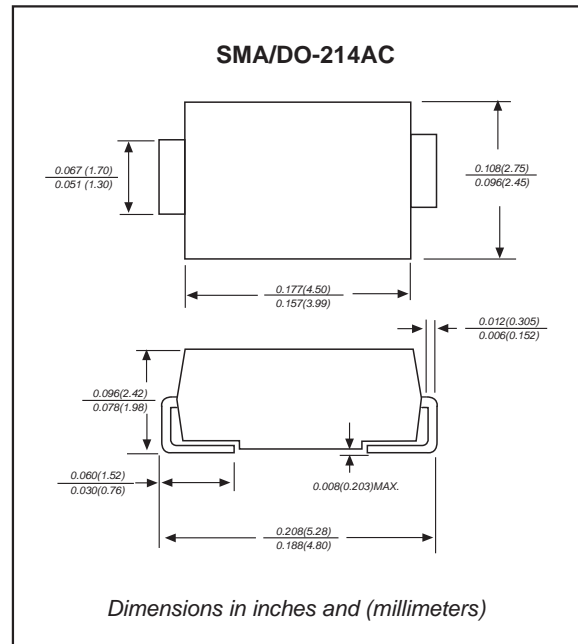
### Features

- ▶ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ▶ For surface mounted applications
- ▶ Fast switching for high efficiency
- ▶ Low reverse leakage
- ▶ Built-in strain relief, ideal for automated placement
- ▶ High forward surge current capability
- ▶ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ▶ Glass passivated chip junction
- ▶ Compliant to RoHS Directive 2011/65/EU
- ▶ Compliant to Halogen-free
- ▶ Suffix "-Q1" for AEC-Q101

### Mechanical data

- ▶ **Case:** JEDEC DO-214AC molded plastic body
- ▶ **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026
- ▶ **Polarity:** Color band denotes cathode end
- ▶ **Mounting Position:** Any
- ▶ **Weight:** 0.002 ounce, 0.07 grams

### Package outline



### Maximum ratings and Electrical Characteristics (AT T<sub>A</sub>=25°C unless otherwise noted)

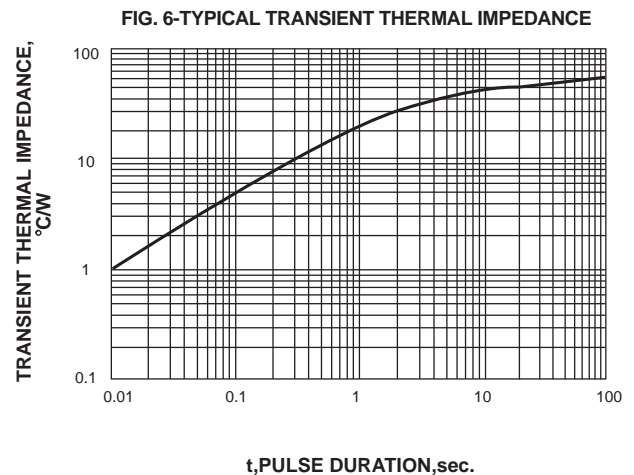
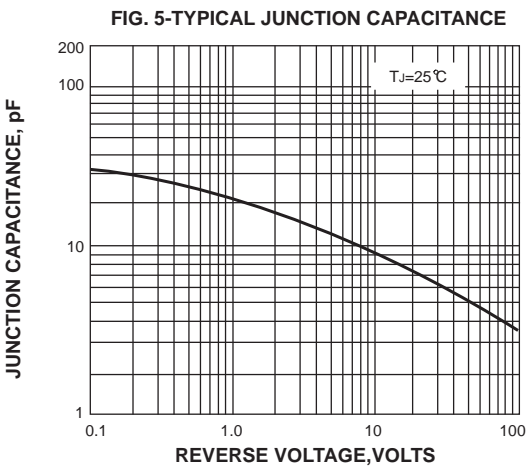
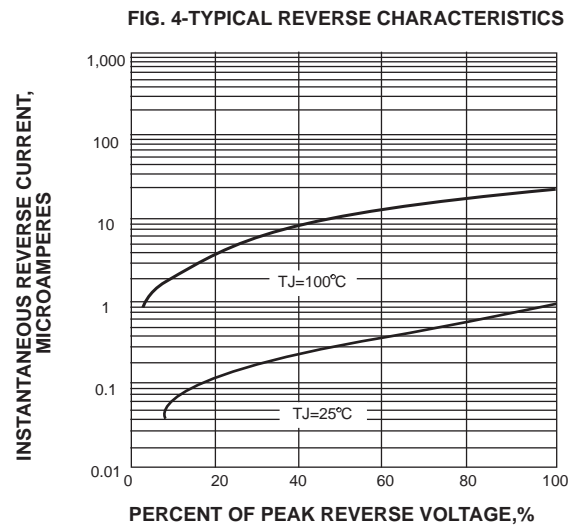
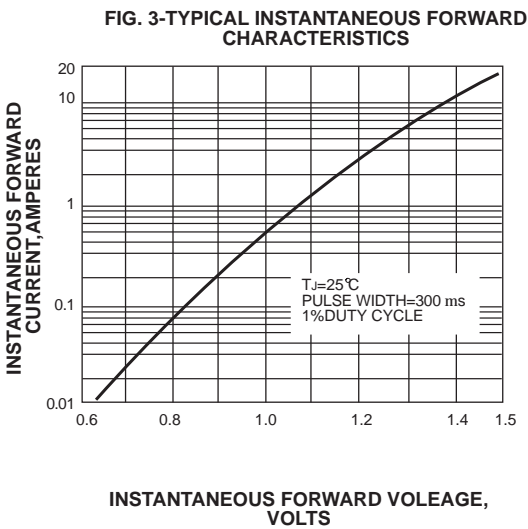
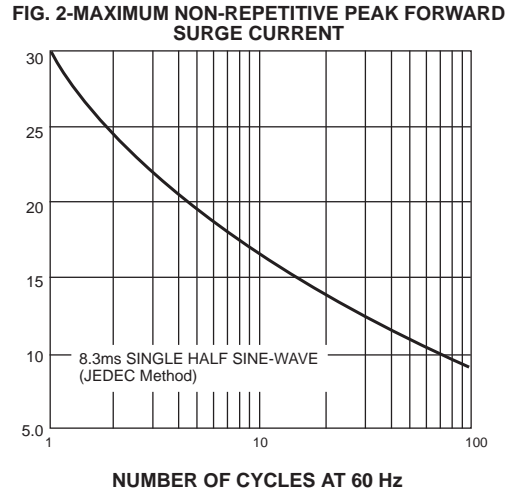
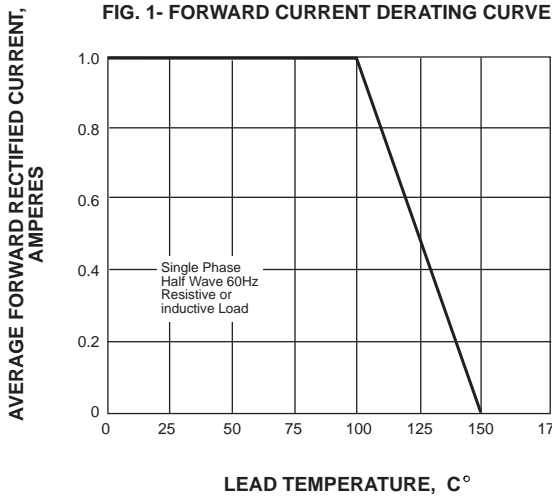
PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.2	I <sub>O</sub>			1.0	A
Forward surge current	8.3ms single half sine-wave (JEDEC method)	I <sub>FSM</sub>			30	A
Reverse current	V <sub>R</sub> = V <sub>RRM</sub> T <sub>A</sub> = 25°C	I <sub>R</sub>			5.0	μA
	V <sub>R</sub> = V <sub>RRM</sub> T <sub>A</sub> = 100°C				50	
Thermal resistance	Junction to ambient NOTE 1	R <sub>θJA</sub>		50		°C/W
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C <sub>J</sub>		15		pF
Storage temperature		T <sub>STG</sub>	-65		+150	°C

SYMBOLS	V <sub>RRM</sub> <sup>*1</sup> (V)	V <sub>RMS</sub> <sup>*2</sup> (V)	V <sub>R</sub> <sup>*3</sup> (V)	V <sub>F</sub> <sup>*4</sup> (V)	t <sub>rr</sub> <sup>*5</sup> (ns)	Operating temperature T <sub>Jr</sub> (°C)
RS1A-A-Q1	50	35	50	1.30	150	-55 to +150
RS1B-A-Q1	100	70	100			
RS1D-A-Q1	200	140	200			
RS1G-A-Q1	400	280	400		250	
RS1J-A-Q1	600	420	600			
RS1K-A-Q1	800	560	800			
RS1M-A-Q1	1000	700	1000	500		



- \*1 Repetitive peak reverse voltage
- \*2 RMS voltage
- \*3 Continuous reverse voltage
- \*4 Maximum forward voltage@I<sub>F</sub>=1.0A
- \*5 Maximum Reverse recovery time, note 2

**Note:** 1.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas  
2. Reverse recovery time test condition, I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

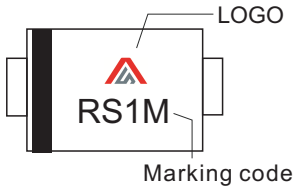
### Rating and characteristic curves



### Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

### Marking

Type number	Marking code	Example
RS1A-A-Q1	RS1A	
RS1B-A-Q1	RS1B	
RS1D-A-Q1	RS1D	
RS1G-A-Q1	RS1G	
RS1J-A-Q1	RS1J	
RS1K-A-Q1	RS1K	
RS1M-A-Q1	RS1M	

### Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SMA	0.110 (2.80)	0.063 (1.60)	0.087 (2.20)